IN THE CLAIMS:

1-2. (Cancelled)

3. (Previously Presented) A microstrip line comprising:

a ground conductor layer;

a dielectric layer disposed on the ground conductor layer;

a linear conductor layer disposed on the dielectric layer to have a linear configuration, the linear conductor layer having a wider portion in an upper part of a cross section thereof taken in a direction perpendicular to a direction in which the linear conductor layer extends and a narrower portion in a lower part of the cross section, the narrower portion being smaller in width than the wider portion and a substrate for holding the ground conductor layer, the substrate being located under the ground conductor layer composed of a dielectric material, wherein the dielectric layer has a dielectric constant higher than a dielectric constant of the substrate,

wherein the dielectric layer contains a titanium oxide.

4. (Previously Presented) A microstrip line comprising:

a ground conductor layer;

a dielectric layer disposed on the ground conductor layer;

a linear conductor layer disposed on the dielectric layer to have a linear configuration, the linear conductor layer having a wider portion in an upper part of a cross section thereof taken in a direction perpendicular to a direction in which the linear conductor layer extends and a narrower portion in a lower part of the cross section, the narrower portion being smaller in width than the wider portion and a substrate for holding the ground conductor layer, the substrate being located under the ground conductor layer composed of a dielectric material, wherein the dielectric layer has a dielectric constant higher than a dielectric constant of the substrate, wherein the dielectric layer contains a titanium oxide, and

wherein the titanium oxide is a strontium titanate.

5-7. (Cancelled)